

# Embedded 5G Modem

# MDG230-0G001



### INTRODUCTION

The MDG230 is an embedded 5G modem with USB 3.1 interface through its board-to-board connector. It operates as an Ethernet over USB end device that offers 5G connectivity once a SIM card is inserted and pre-configured through user-friendly web GUI. With its intelligent connection monitoring mechanism, it can provide more reliable 5G connection for mission-critical applications.

### **BENEFITS**

- 1. Carrier approval\* cost saving and time-to-market
- 2. Plug and play Linux kernel 5.0 & Windows 10, or higher version.
- 3. Flexible SIM selection support internal SIM / external SIM / dual SIM failover

### **KEY FEATURES**

- √ 5G NR (FR1) / 4G LTE
- ✓ Standalone network-ready
- ✓ 4FF Nano SIM slot
- ✓ Compact Board-to-Board design for system Integration

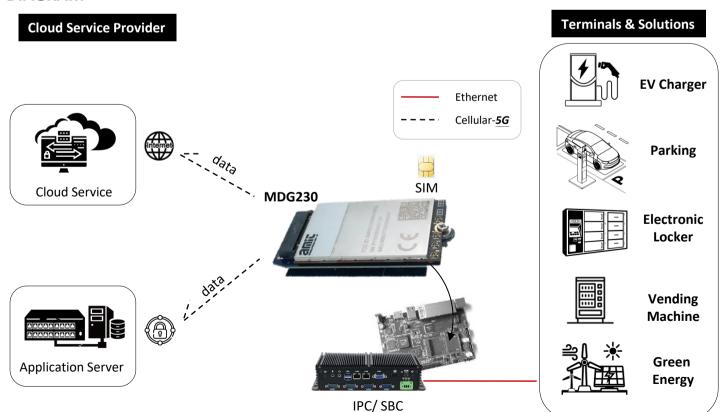
### **APPICATION**

- Industrial PC
- Retail / Point-of-Sales
- Single Board Computer
- Video Surveillance DVR
- Professional A/V solution



+ additional M.2 (3052 B-Key) adapter board

### **DIAGRAM**



### **SPECIFICATION**

### Device Interface

- 5G NR Module: 1\*5G NR FR1 (sub 6GHz)
- 3GPP: Release 16
- **SIM**:1\* 4FF Nano-SIM slot (push-push type) for 1.8V / 3V SIM/USIM,
  - support dual SIM failover through Board-to-Board I/F.
- **5G NR Band (FR1)**: n1/ 2/ 3/ 5/ 7/ 8/ 12/ 13/ 14/ 18/ 20/ 25/ 26/ 28/ 29/ 30/ 38/ 40/ 41/ 48/ 66/ 70/ 71/ 75/ 76/ 77/ 78/ 79
- 4G LTE Band: B1/ 2/ 3/ 4/ 5/ 7/ 8/ 12/ 13/ 14/ 17/ 18/ 19/ 20/ 25/ 26/ 28/ 29/ 30/ 32/ 34/ 38/ 39/ 40/ 41/ 42/ 43/ 46(LAA)/ 48/ 66/ 71
- WCDMA Band: B1/2/4/5/8/19
- Data Interface: USB 3.1 through board-to-board connector
- Power Input: DC 3.3V through board-to-board connector
- Antenna:
  - 4 \*MHF4 receptacle connectors for 5G antenna connection

### WAN & Uplink

•WAN: NAT / Modem mode

### Control Interface

- Web-based GUI: Configuration, Status monitoring
- AT Command: 3GPP TS 27.007 AT commands

### Supported OS

- Linux: Linux kernel 5.0 or higher
- Windows: Windows 10 or higher;

MDG230 driver installation is required.

### Environment

- Operation Temperature\*: -30°C-75°C
- Storage Temperature: -40°C-85°C
- Humidity: 10%~95% (non-condensing)
- Dimension: 60(L)x30(W)x8.6(H) mm

### Certification\*

- FCC
- PTCRB

### Carrier Approval\*

- AT&T
- Verizon

### Standard Package

• 1\*MDG230, 1\* M.2 Adapter Board

### Comment:

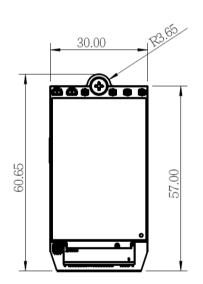
- 1.Linux kernel version 4.x or lower support case-by-case
- 2. Specifications are subject to change without prior notice

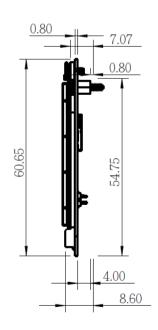
Bottom View

3.\*Under development/in progress

### **MECHANIC DRAWING** (dimension marked in millimeter)

• MDG230





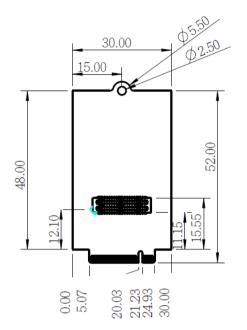
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### Note:

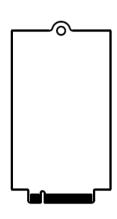
- Specifications are subject to change without prior notice.
- Additional thermal solution is required to get well performance.
- Certification and carrier approvals are under implementation, check with sales for the availability.

## **Adapter Board**

# • M.2 Adapter (MCG230)







# • MDG230 + M.2 Adapter (MCG230)

